

N- and P-Channel 20-V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | | | | | |
|-----------------|---------------------|--------------------------------------|--------------------|-----------------------|--|--|--|--|--|
| | V _{DS} (V) | $R_{DS(on)}(\Omega)$ | I _D (A) | Q _g (Typ.) | | | | | |
| N-Channel | 20 | 0.060 at V _{GS} = 4.5 V | 4.5 ^a | 3.5 nC | | | | | |
| N-Channel | | 0.092 at V _{GS} = 2.5 V | 4.5 ^a | 3.5 110 | | | | | |
| P-Channel | - 20 | 0.110 at V _{GS} = - 4.5 V | - 4.5 ^a | 3 nC | | | | | |
| | | 0.185 at $V_{GS} = -2.5 \text{ V}$ | - 4.5 ^a | 3110 | | | | | |

FEATURES

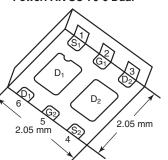
- Halogen-free
- TrenchFET® Power MOSFETs
- New Thermally Enhanced PowerPAK® SC-70 Package
 - Small Footprint Area
 - Low On-Resistance

APPLICATIONS

Portable Devices

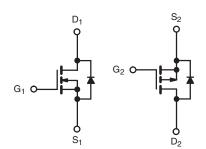


PowerPAK SC-70-6 Dual



Marking Code

Part # code Lot Traceability and Date code



Ordering Information: SiA513DJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET P-Channel MOSFET

| ABSOLUTE MAXIMUM RATING | S $T_A = 25 ^{\circ}C$, unles | ss otherwise | noted | | | |
|--|--|----------------|------------------------|-----------------------|----|--|
| Parameter | Symbol | N-Channel | P-Channel | Unit | | |
| Drain-Source Voltage | V _{DS} | 20 | - 20 | V | | |
| Gate-Source Voltage | V_{GS} | ± | V | | | |
| | T _C = 25 °C | | 4.5 ^a | - 4.5 ^a | | |
| Continuous Drain Current (T _J = 150 °C) | T _C = 70 °C | ı | 4.5 ^a | - 4.5 ^a | А | |
| | T _A = 25 °C | I _D | 4.5 ^{a, b, c} | - 3.3 ^{b, c} | | |
| | T _A = 70 °C | | 3.2 ^{b, c} | - 2.4 ^{b, c} | | |
| Pulsed Drain Current | I _{DM} | 15 | - 10 | | | |
| Source Drain Current Diode Current | T _C = 25 °C | I _S | 4.5 ^a | - 4.5 ^a | | |
| Source Drain Current Diode Current | T _A = 25 °C | | 1.6 ^{b, c} | - 1.6 ^{b, c} | | |
| | T _C = 25 °C | | 6.5 | 6.5 | | |
| Maximum Power Dissipation | T _C = 70 °C | | 5 | 5 | W | |
| Maximum Power Dissipation | T _A = 25 °C | P_{D} | 1.9 ^{b, c} | 1.9 ^{b, c} | VV | |
| | T _A = 70 °C | | 1.2 ^{b, c} | 1.2 ^{b, c} | | |
| Operating Junction and Storage Temperature R | T _J , T _{stg} | - 55 t | | | | |
| Soldering Recommendations (Peak Temperatur | e) ^{d, e} | _ | 20 | 60 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | | | | | | |
|---|--------------|-------------------|-------|-------|-------|------|----------------------|--|--|--|
| | | N-Ch | annel | P-Cha | annel | | | | | |
| Parameter | Symbol | Тур. | Max. | Тур. | Max. | Unit | | | | |
| Maximum Junction-to-Ambient ^{b, f} | t ≤ 5 s | R _{thJA} | 52 | 65 | 52 | 65 | °C/W | | | |
| Maximum Junction-to-Case (Drain) | Steady State | R_{thJC} | 12.5 | 16 | 12.5 | 16 | <i>5/</i> V V | | | |

Notes:

- a. Package limited.
- b. Surface Mounted on 1" x 1" FR4 board.
- d. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
 e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under Steady State conditions is 110 °C/W.

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| Parameter | Symbol | Test Conditions | | Typ. Max. | | Unit | | |
|---|-------------------------|---|--------------|-----------|-------|-------|-------|--|
| Static | | | | | | l | | |
| D : 0 | | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | N-Ch | 20 | | | ., | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$ | P-Ch | - 20 | | | V | |
| V Tamanayahiya Caaffiniant | A) / /T | I _D = 250 μA | N-Ch | | 22 | | mV/°C | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | I _D = - 250 μA | P-Ch | | - 16 | | | |
| V Tompovotive Coefficient | A)/ /T | I _D = 250 μA | N-Ch | | - 3.5 | | | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = - 250 μA | P-Ch | | 2.5 | | | |
| Cata Threshold Voltage | V | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | N-Ch | 0.6 | | 1.5 | V | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250 \mu A$ | P-Ch | - 0.6 | | - 1.5 | ľ | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$ | N-Ch | | | ± 100 | nA | |
| date body Leakage | '688 | | P-Ch | | | ± 100 | ПА | |
| | | $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$ | N-Ch | | | 1 | μΑ | |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$ | P-Ch | | | - 1 | | |
| Zero date voltage Brain Gurrent | .088 | $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$ | N-Ch | | | 10 | | |
| | | V_{DS} = - 20 V, V_{GS} = 0 V, T_J = 55 °C | P-Ch | | | - 10 | | |
| 0 0 1 D 1 0 1h | 1 | $V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$ | | 10 | | | Λ | |
| On-State Drain Current ^b | I _{D(on)} | $V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$ | P-Ch | - 5 | | | Α | |
| | | $V_{GS} = 4.5 \text{ V}, I_D = 3.4 \text{ A}$ | N-Ch | | 0.050 | 0.060 | | |
| Drain-Source On-State Resistance ^b | R _{DS(on)} | $V_{GS} = -4.5 \text{ V}, I_D = -2.5 \text{ A}$ | P-Ch | | 0.091 | 0.110 | Ω | |
| | | $V_{GS} = 2.5 \text{ V}, I_D = 1.1 \text{ A}$ | N-Ch | | 0.076 | 0.092 | | |
| | | $V_{GS} = -2.5 \text{ V}, I_D = -0.54 \text{ A}$ | P-Ch | | 0.152 | 0.185 | | |
| b | | $V_{DS} = 10 \text{ V}, I_D = 3.4 \text{ A}$ | N-Ch | | 8 | | S | |
| Forward Transconductance ^b | 9 _{fs} | V _{DS} = - 10 V, I _D = - 2.5 A | P-Ch | | 3.5 | | | |
| Dynamic ^a | | | | | | | • | |
| Input Conscitance | C _{iss} | | N-Ch | | 360 | | | |
| Input Capacitance | Oiss | N-Channel | P-Ch | | 250 | | | |
| Output Capacitance | C _{oss} | $V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | N-Ch | | 70 | | pF | |
| Odiput Odpustianos | - 055 | P-Channel | P-Ch | | 70 | | | |
| Reverse Transfer Capacitance | C _{rss} | $V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | N-Ch | | 40 | | | |
| · | | V 40VV 40VI 45A | P-Ch | | 45 | 40 | | |
| | | $V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 4.5 \text{ A}$ | N-Ch | | 7.5 | 12 | | |
| Total Gate Charge | Q_g | $V_{DS} = -10 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -3.3 \text{ A}$ | P-Ch | | 6 | 9 | nC | |
| | | N-Channel | N-Ch | | 3.5 | 5.3 | | |
| | | $V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 4.5 \text{ A}$ | P-Ch N-Ch | | 0.9 | 4.5 | | |
| Gate-Source Charge | Q_{gs} | | P-Ch | | 0.7 | | | |
| | | P-Channel $V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -3.3 \text{ A}$ | N-Ch | | 0.7 | | | |
| Gate-Drain Charge | Q_{gd} | V _{DS} = - 10 v, v _{GS} = - 4.0 v, 1 _D = - 3.3 A | P-Ch | | 0.9 | | 1 | |
| Cota Decistanas | В | £ 4 NALI_ | N-Ch | | 2.5 | | | |
| Gate Resistance | R_g | f = 1 MHz | P-Ch | | 8 | | Ω | |

- a. Guaranteed by design, not subject to production testing. b. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.



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| Parameter | Symbol | Test Conditions | Min. | Typ. | Max. | Unit | |
|--|---------------------|---|------|------|-------|-------|-----|
| Dynamic ^a | - | | | | | | |
| Turn-On Delay Time | t _{d(on)} | N Channel | N-Ch | | 10 | 15 | |
| Tan on Bolay Timo | -u(on) | N-Channel $V_{DD} = 10 \text{ V, } R_L = 2.8 \Omega$ | P-Ch | | 20 | 30 | |
| Rise Time | t _r | $I_D \cong 3.6 \text{ A, } V_{GEN} = 4.5 \text{ V, } R_a = 1 \Omega$ | N-Ch | | 40 | 60 | |
| 11100 111110 | 71 | 1D = 0.0 /1, VGEN = 4.0 V, Fig = 1.32 | P-Ch | | 45 | 70 | |
| Turn-Off Delay Time | t _{d(off)} | P-Channel | N-Ch | | 20 | 30 | |
| | u(on) | $V_{DD} = -10 \text{ V}, R_{L} = 3.9 \Omega$ | P-Ch | | 15 | 25 | |
| Fall Time | t _f | $I_D \cong$ - 2.6 A, V_{GEN} = - 4.5 V, R_g = 1 Ω | N-Ch | | 30 | 45 | |
| | ' | | P-Ch | | 10 | 15 | ns |
| Turn-On Delay Time | t _{d(on)} | N-Channel | N-Ch | | 5 | 10 | |
| | -u(on) | $V_{DD} = 10 \text{ V}, R_L = 2.8 \Omega$ | P-Ch | | 4 | 8 | |
| Rise Time | t _r | $I_D \cong 3.6 \text{ A, } V_{GEN} = 10 \text{ V, } R_g = 1 \Omega$ | N-Ch | | 15 | 25 | |
| | | D = 0.013, 1GEN 10 13, 19 | P-Ch | | 12 | 20 | |
| Turn-Off Delay Time | t _{d(off)} | P-Channel | N-Ch | | 15 | 25 | |
| | | $V_{DD} = -10 \text{ V}, R_{L} = 3.9 \Omega$ | P-Ch | | 12 | 20 | |
| Fall Time | t _f | $I_D \cong$ - 2.6 A, V_{GEN} = - 10 V, R_g = 1 Ω | N-Ch | | 10 | 15 | |
| | | | P-Ch | | 5 | 10 | |
| Drain-Source Body Diode Characteristic | cs | 1 | | I | 1 | | |
| Continuous Source-Drain Diode Current | I _S | T _C = 25 °C | N-Ch | | | 4.5 | A A |
| | | - | P-Ch | | | - 4.5 | |
| Pulse Diode Forward Current ^a | I _{SM} | | N-Ch | | | 15 | |
| | | 1 004 1/ 01/ | P-Ch | | | - 10 | |
| Body Diode Voltage | V_{SD} | I _S = 3.6 A, V _{GS} = 0 V | N-Ch | | 0.8 | 1.2 | V |
| <i>.</i> | 0.5 | I _S = - 2.6 A, V _{GS} = 0 V | P-Ch | | - 0.8 | - 1.2 | |
| Body Diode Reverse Recovery Time | t _{rr} | | N-Ch | | 15 | 30 | ns |
| | 41 | N-Channel | P-Ch | | 20 | 40 | |
| Body Diode Reverse Recovery Charge | Q_{rr} | $I_F = 3.6 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$ | N-Ch | | 10 | 20 | nC |
| | 11 | | P-Ch | | 10 | 20 | |
| Reverse Recovery Fall Time | t _a | P-Channel | N-Ch | | 10 | | |
| | a | $I_F = -2.6 \text{ A}, \text{ di/dt} = -100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$ | P-Ch | | 8 | | ns |
| Reverse Recovery Rise Time | t _b | | N-Ch | | 5 | | |
| , | | | P-Ch | | 12 | | |

Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

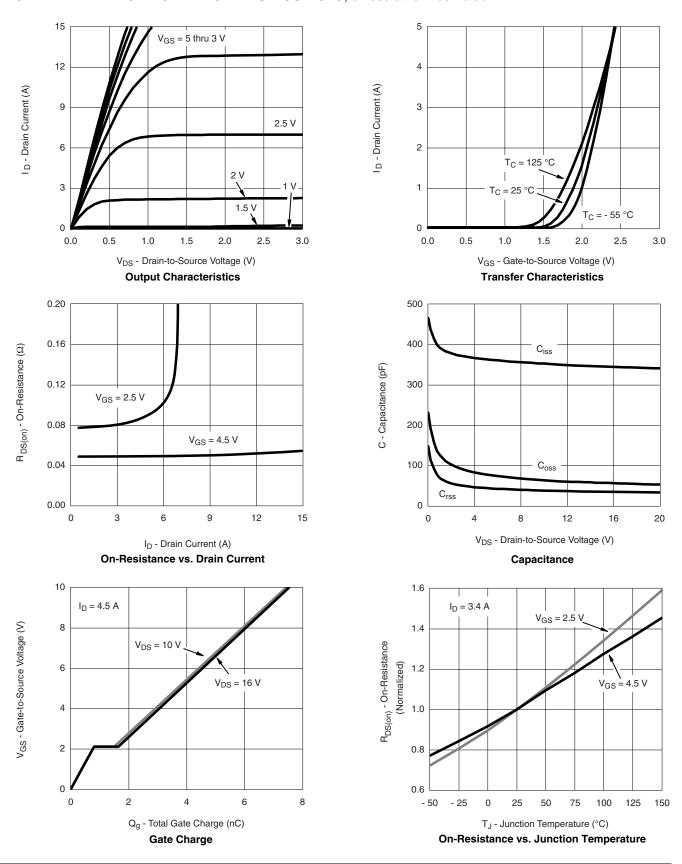
a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$

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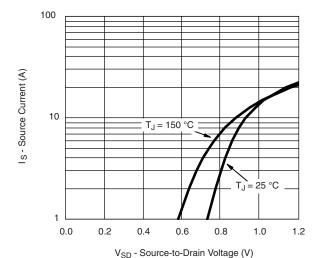


N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

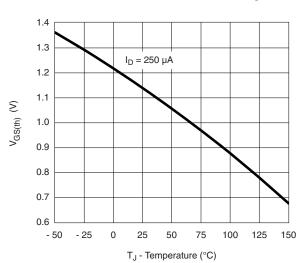




N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Source-Drain Diode Forward Voltage



Threshold Voltage

0.30

0.25

0.25

0.20

0.15

0.10

0.05

0.00

0.10

0.05

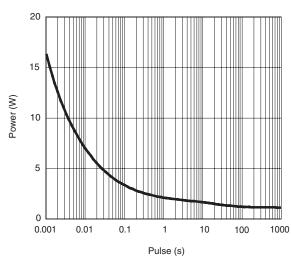
0.00

0.10

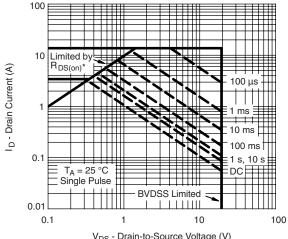
0.25

V_{GS} - Gate-to-Source Voltage (V)

On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power



 V_{DS} - Drain-to-Source Voltage (V) * V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient

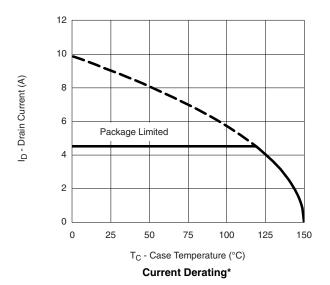
Power Dissipation (W)

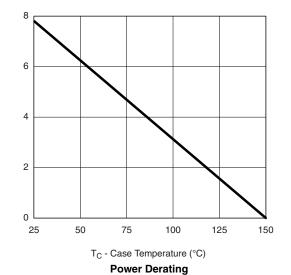
SiA513DJ

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N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



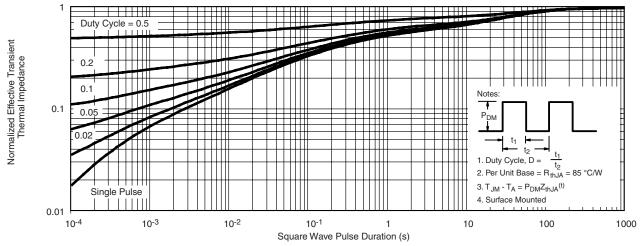


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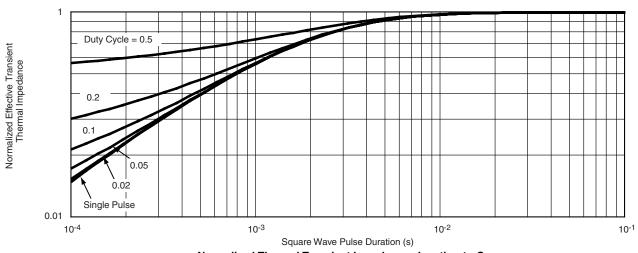
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient

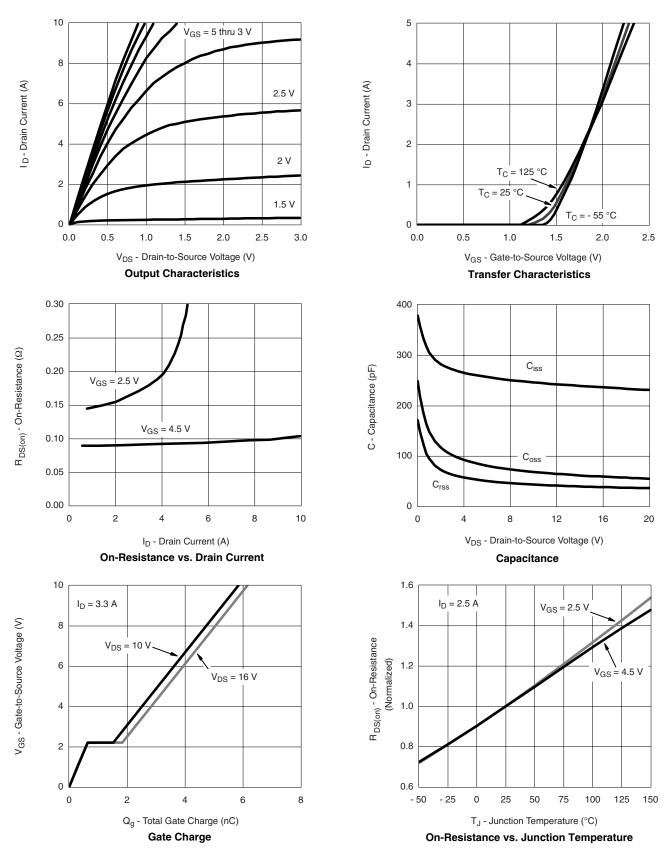


Normalized Thermal Transient Impedance, Junction-to-Case

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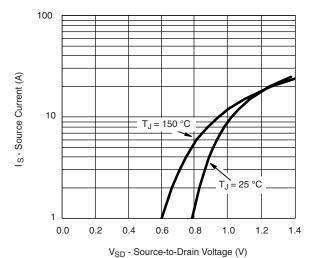


P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

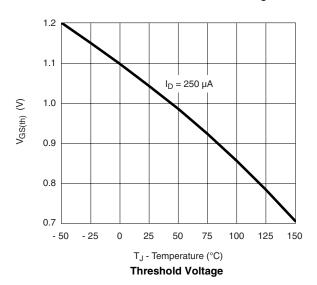


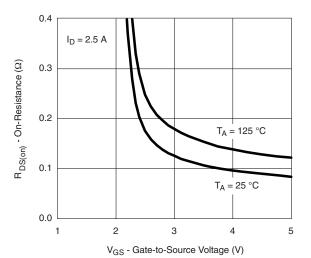


P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

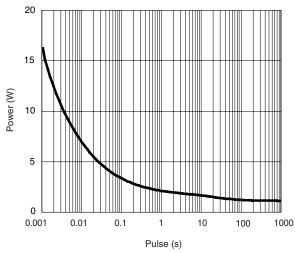


Source-Drain Diode Forward Voltage

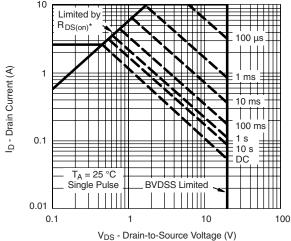




On-Resistance vs. Gate-to-Source



Single Pulse Power



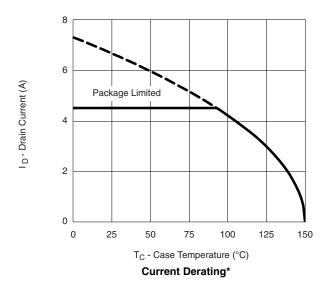
* V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

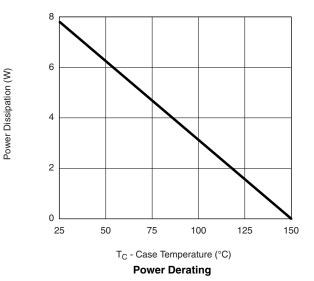
Safe Operating Area, Junction-to-Ambient

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P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





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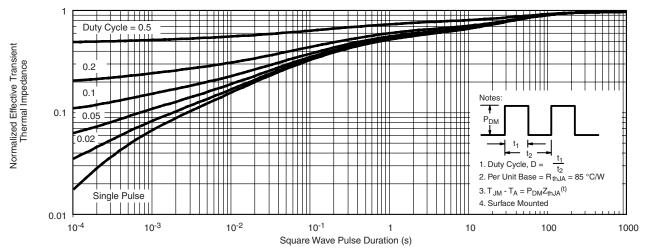
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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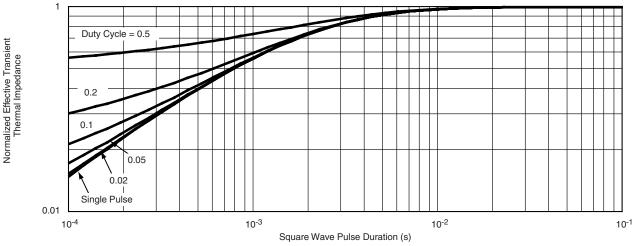


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P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient

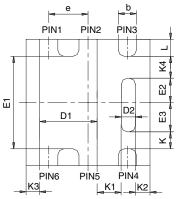


Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?70443.

Document Number: 70443 www.vishay.com S-80437-Rev. B, 03-Mar-08

PowerPAK® SC70-6L





BACKSIDE VIEW OF SINGLE

BACKSIDE VIEW OF DUAL



- All dimensions are in millimeters
 Package outline exclusive of mold flash and metal burr
 Package outline inclusive of plating

| | SINGLE PAD | | | | | | DUAL PAD | | | | | |
|------------|-------------|-----------|-------|---------------------|-----------|-------|-------------|----------|-----------|--------|-----------|-------|
| DIM | MILLIMETERS | | | INCHES | | | MILLIMETERS | | | INCHES | | |
| | Min | Nom | Max | Min | Nom | Max | Min | Nom | Max | Min | Nom | Max |
| Α | 0.675 | 0.75 | 0.80 | 0.027 | 0.030 | 0.032 | 0.675 | 0.75 | 0.80 | 0.027 | 0.030 | 0.032 |
| A 1 | 0 | - | 0.05 | 0 | - | 0.002 | 0 | - | 0.05 | 0 | - | 0.002 |
| b | 0.23 | 0.30 | 0.38 | 0.009 | 0.012 | 0.015 | 0.23 | 0.30 | 0.38 | 0.009 | 0.012 | 0.015 |
| С | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 |
| D | 1.98 | 2.05 | 2.15 | 0.078 | 0.081 | 0.085 | 1.98 | 2.05 | 2.15 | 0.078 | 0.081 | 0.085 |
| D1 | 0.85 | 0.95 | 1.05 | 0.033 | 0.037 | 0.041 | 0.513 | 0.613 | 0.713 | 0.020 | 0.024 | 0.028 |
| D2 | 0.135 | 0.235 | 0.335 | 0.005 | 0.009 | 0.013 | | | | | | |
| Е | 1.98 | 2.05 | 2.15 | 0.078 | 0.081 | 0.085 | 1.98 | 2.05 | 2.15 | 0.078 | 0.081 | 0.085 |
| E1 | 1.40 | 1.50 | 1.60 | 0.055 | 0.059 | 0.063 | 0.85 | 0.95 | 1.05 | 0.033 | 0.037 | 0.041 |
| E2 | 0.345 | 0.395 | 0.445 | 0.014 | 0.016 | 0.018 | | | | | | |
| E3 | 0.425 | 0.475 | 0.525 | 0.017 | 0.019 | 0.021 | | | | | | |
| е | | 0.65 BSC | | | 0.026 BSC | ; | | 0.65 BSC | | | 0.026 BSC | ; |
| K | 0.275 TYP | | | | 0.011 TYP | 1 | 0.275 TYP | | | | 0.011 TYP | |
| K1 | | 0.400 TYP | 1 | | 0.016 TYP | ı | 0.320 TYP | | | | 0.013 TYP | 1 |
| K2 | | 0.240 TYP | 1 | 0.009 TYP 0.252 TYP | | | | | 0.010 TYP | | | |
| К3 | | 0.225 TYP | 1 | 0.009 TYP | | | | | | | | |
| K4 | | 0.355 TYP | 1 | 0.014 TYP | | | | | | | | |
| L | 0.175 | 0.275 | 0.375 | 0.007 | 0.011 | 0.015 | 0.175 | 0.275 | 0.375 | 0.007 | 0.011 | 0.015 |
| T | | | | | | | 0.05 | 0.10 | 0.15 | 0.002 | 0.004 | 0.006 |

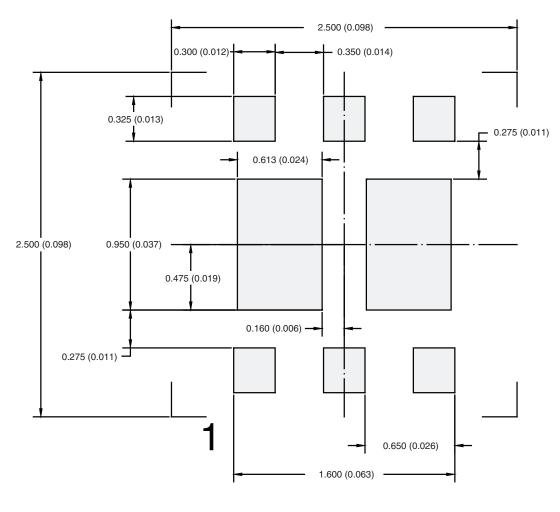
DWG: 5934

Document Number: 73001

06-Aug-07



RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Dual



Dimensions in mm (inches)

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APPLICATION NOTE

www.vishay.com Document Number: 70487

1 Revision: 18-Oct-13

Legal Disclaimer Notice



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